

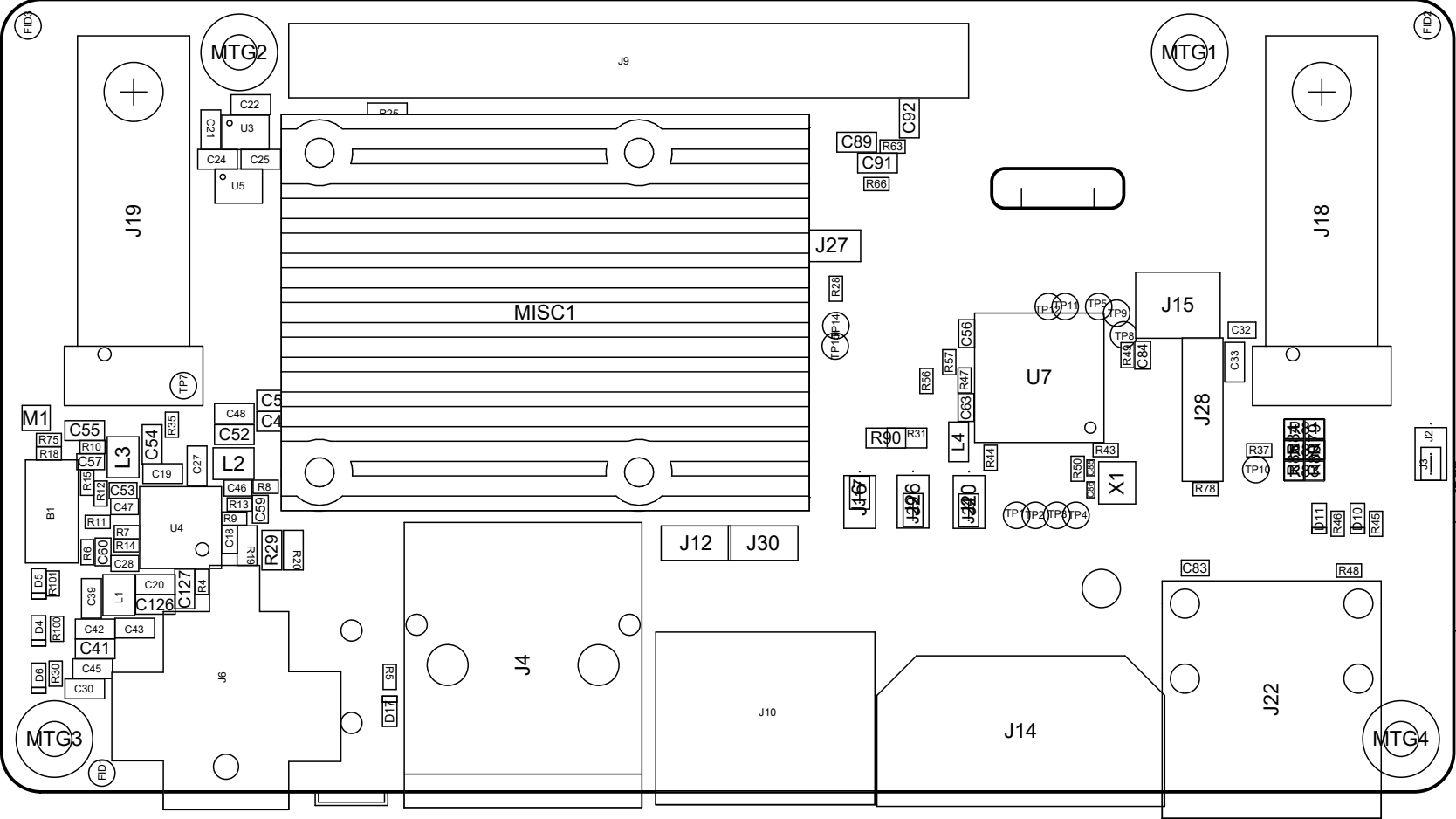
ASSEMBLY NOTES:


Assembly shall conform to IPC-A-610 Class 2.
Assembly shall conform with RoHS Directive 2011/65/EU.
Components shall be placed according to the associated CPL and BOM documents.
Lead-free SAC305 solder shall be used.
Reflow profile shall comply with J-STD-20C Lead-Free Reflow Profile.
BGA components shall be 100% checked with x-ray for solder bridges after reflow.
Finished assemblies shall be removed from panel prior to delivery.

Notes:

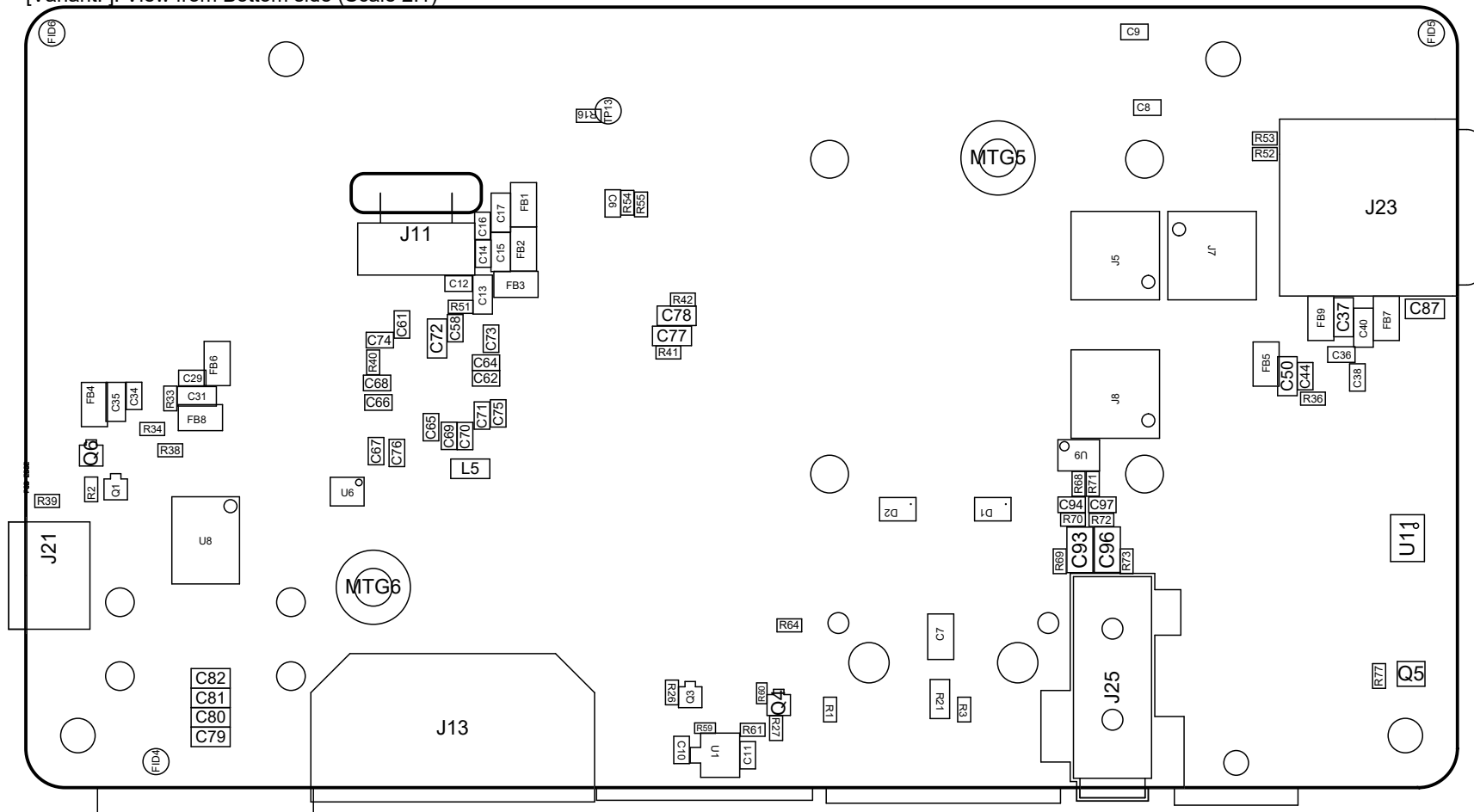
- 1 Note 1: Receptacles for CM4 and J1 are the same (3pcs)
- 2 Note 2: Last page is withot CM4
- 3 Note 3


View from Top side (Scale 2:1)

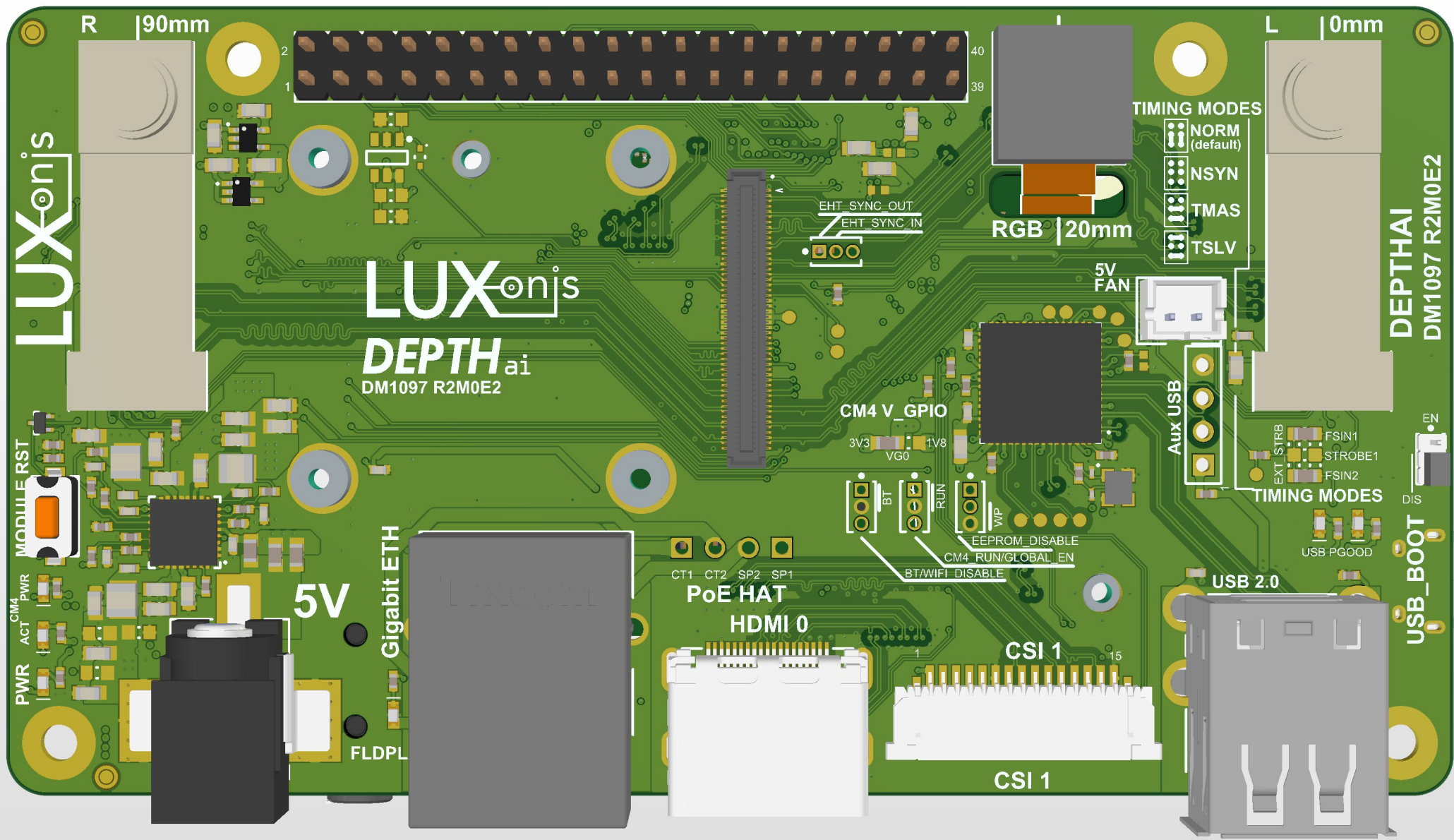


Title: DM1097	
Number: D0000200 Revision: R2M0 E2	
Date: 31/08/2021 Sheet: 2 of 3	
Drawn by: David Malovrh	

[Variant:]: View from Bottom side (Scale 2:1)

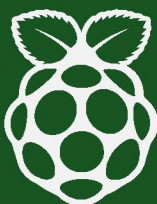


Title: DM1097		
Number: D0000200	Revision: R2M0 E2	
Date: 31/08/2021	Sheet: 3 of 3	PROPRIETARY AND CONFIDENTIAL
Drawn by: David Malovrh		THE INFORMATION CONTAINED IN THIS DRAWING IS THE SOLE PROPERTY OF LUXONIS HOLDING CORPORATION. ANY REPRODUCTION IN PART OR AS A WHOLE WITHOUT THE WRITTEN PERMISSION IS PROHIBITED.





LUXonjis
DEPTH_{ai}
DM1097 R2M0E2



uSD card
Used only for CM4 Lite

AUX IO SPI

3.3V SD

DSI 1

DSI 1

AUDIO